Atty. Docket No. CPAC 1029-2
Appl. No. 10/681,572

PATENT

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Marcos Karnezos	Examiner: Alonzo Chambliss
Application No.: 10/681,572	Group Art Unit: 2814
Filed: October 8, 2003	Date: November 3, 2005 .
Title: **Semiconductor multi-package module having inverted second package**	CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first class mail in an envelope addressed to: MS Amendment, Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on November 3, 2005 .

Signed _____
Paula Faulk Hurley

COMMISSIONER FOR PATENTS
P.O. BOX 1450
Alexandria, VA 22313-1450

AMENDMENT

Dear Sir:

In response to the Office action mailed August 4, 2005, kindly amend the application as follows.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the **Listing of Claims** beginning on page 3 of this paper.

Remarks begin on page 5 of this paper.